



Intel's TRIZ Journey

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Agenda

- TRIZ in Intel
- Why is TRIZ so important to Intel?
- TRIZ training overview
- TRIZ Proliferation & Adoption:
Challenges & Strategies
 - Manufacturing Case Study
- Key Learning, Summary & Conclusion

TRIZ in Intel

- Driven by manufacturing groups
 - **Fab/Sort Manufacturing**
 - **Assembly/Test Manufacturing (ATM)**
 - Focus area: to improve equipment performance
 - Boundary conditions for equipment solutions: Effective & low cost (small changes due to large equipment base)



TRIZ at Intel

- **1996-2001 Early exploration stage** Curious early adopters
 - 1996, Santa Clara Technology Development - Began TRIZ software pilot/training. Two very successful projects – “Sputnik” and “Bubbles”
 - 1998 Introduced to Assembly Technology Development and Flash Business
- **2002-2004 Early deployment and seeding in Mfg.** Champion - Evangelist
 - 2002 First TRIZ class in Assembly/Test Mfg. – Cavite, Philippines
 - 2003 First class in Fab/Sort Mfg. – Kiryat Gat, Israel
 - 2004 Classes in more sites (Fab/Sort and Assembly/Test)
- **2005-2006 Adoption – Manufacturing world-wide** Leader - Proliferators
 - 2005 First classes to Level-2 and Level-3
 - 2006 All Level-1, Level-2 classes delivered internally
- **2007-2008**
 - Manufacturing expansion
 - R&D Introduction
 - Connectivity with other methods
- **2009 -> into the future**
 - Expanding existing use
 - New fields of application
 - Synergy with other methods:
 - Lean, Six-sigma, TOC...



Intel's 1st TRIZ Summit Conference

Chandler, Arizona - Dec 2007

- Intel wide conference held in 2007.
- Conference Theme: “Innovating the Future”
- Over 150 attendees from around the world (40 non-US).
- 6 papers, 28 posters showcasing work across multi-disciplines
- Invited talks by Intel Fellows, industry experts, TRIZ masters



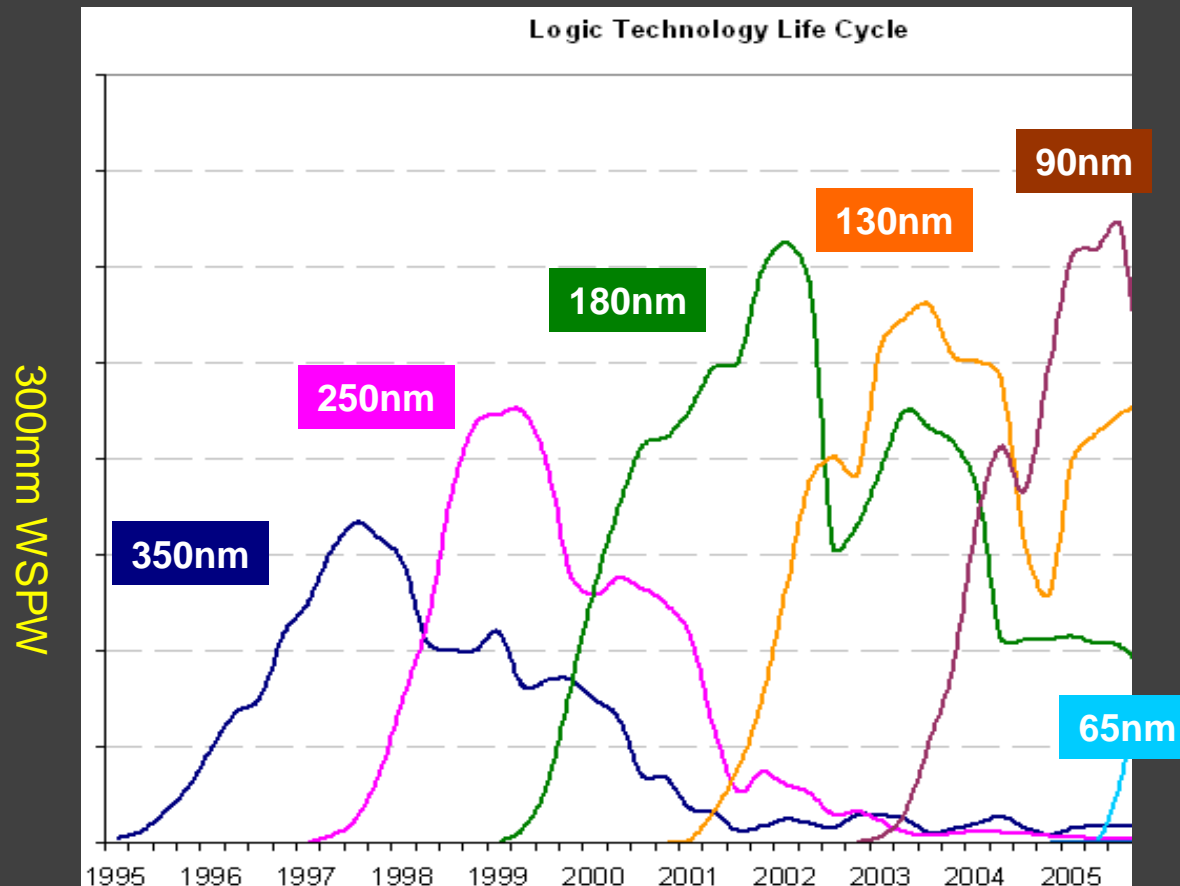
Why is TRIZ so important to Intel?

- Why problem solving is so critical in our current business model
- Our manufacturing objectives



Why is it important for Intel to solve manufacturing problems quickly?

Each new technology has a shorter life cycle and requires a faster ramp rate than previous technologies. Problems incurred are much more costly per day than they have ever been.



Intel's Manufacturing Mission

To be the best at:

Ramping new products into high volume

Yields

Tool productivity

Cost and agility

**In order to achieve our goals, problems must be quickly contained,
and with root cause understanding.**

This is why we adopt TRIZ

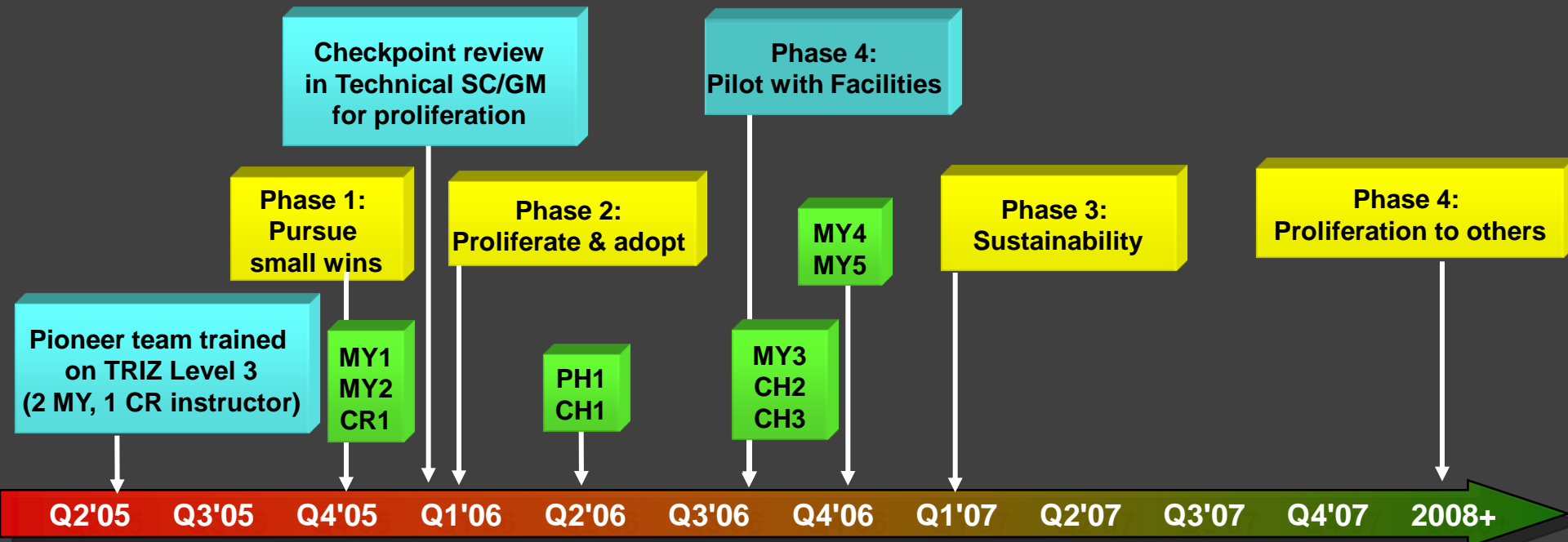
TRIZ Proliferation & Adoption - Challenges & Strategies

**Organization case study:
Assembly/Test Manufacturing (ATM)
Asia**

TRIZ Implementation Roadmap

■ Key Phases

- Phase 1: Pursue small wins
- Phase 2: Proliferation & adoption
- Phase 3: Sustainability
- Phase 4: Proliferation to others

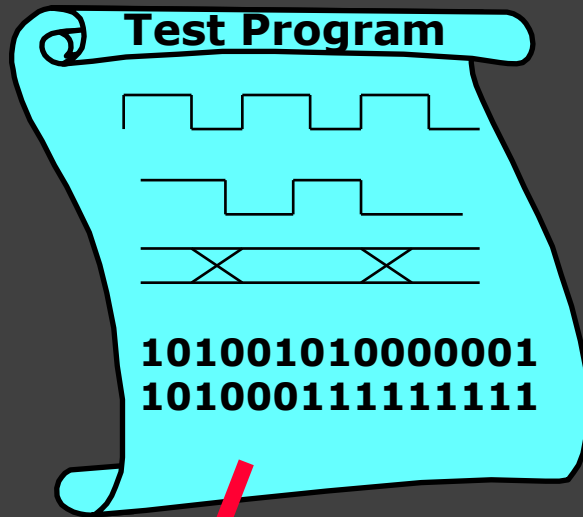


Phase 1 - Pursue Small Wins

- **Challenge: Show that TRIZ works**
- **Strategies: Pilot & get small wins**
 - **Engaged 3 factories (2 MY, 1 CR)**
 - Proximity of instructors (MY/CR) to factory
 - Presented TRIZ overview to factory's direct staff
 - Need solid value proposition: Accelerates problem solving tpt & generates innovative solutions vs. time out for training
 - Networking & trust - very important
 - Requested for engineers to be identified. Bring unsolved problems to 5-day Basic TRIZ training class
 - **Demonstrate value add**
 - Managed to generate effective and innovative solutions which included test handler which was >10 years old; and problem had existed for >3 years

Early stages - pursue small wins, show value add

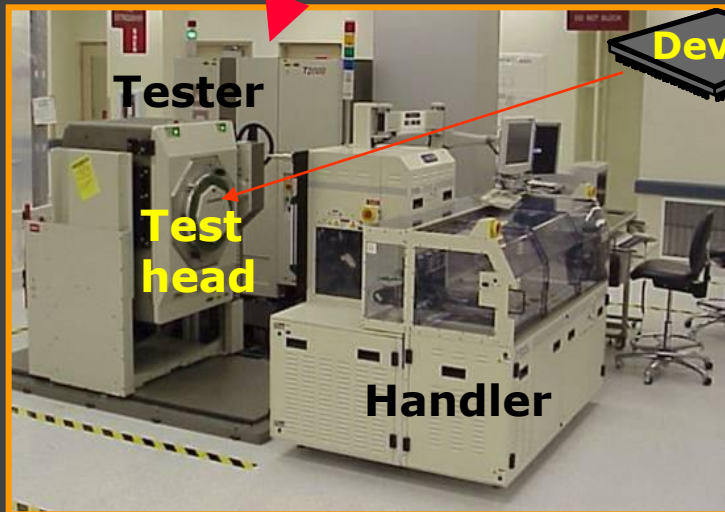
Test manufacturing - brief introduction



Code generation

Vector generation /validation

Software



Device

Hardware

3.2.1.4 General Purpose Digital-to-analog Converter

The general purpose DAC is used for control functions.

Table 11. Monitor and Control DAC General Description

Parameter	Description
Resolution	
Output type	
Reference	

Table 12. Monitor and Control DAC Performance Characteristics

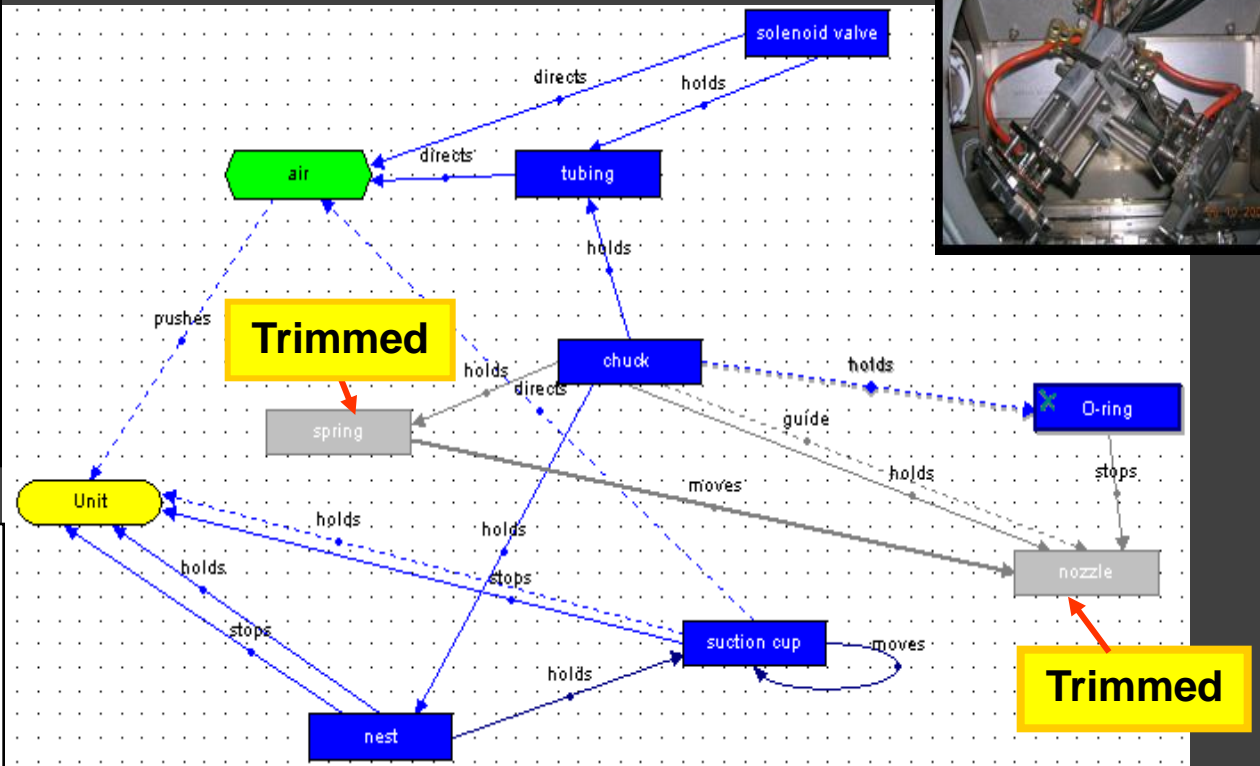
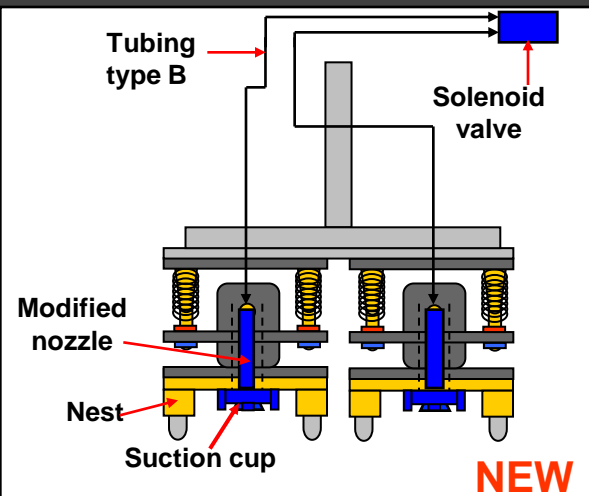
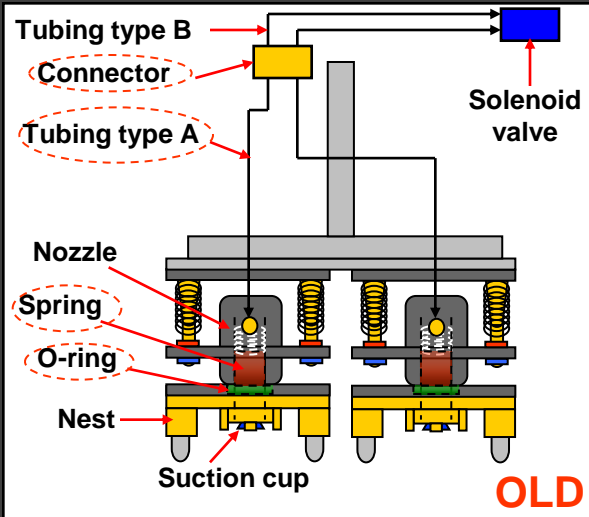
Parameter	Min	Typ	Max	Units
Conversion rate	0.1	10		Maps
DAC_VDD range (powered by the Intel® PRO Wireless 5110's 2.3 analog VDD)	3	3.6		V
DAC digital voltage (powered by the Intel® PRO Wireless 5110's 1.2 analog VDD)	1.1	1.3		V
Integral nonlinearity	-1	+1		LSB
Differential linearity	-0.5	+0.5		LSB
Zero code error		2		LSB
Output range without damage	0	DAC_VDD - 0.2		V
Output load compliance		10		kΩ
Maximum stable load		10		pF
Linear output range		GPDACX_REF_M	GPDACX_REF_P	V
High-reference range (GPDACX_REF_P [†])	0.5	DAC_VDD - 0.2		V
Low-reference range (GPDACX_REF_M) [†]	0	DAC_VDD - 1.6		V
Settling time (to < 1% error)		100		ns

[†] GPDACX_REF_P > GPDACX_REF_M

Device Datasheet

Results & case studies in next slides ...

Case #1: Pick & place suction force

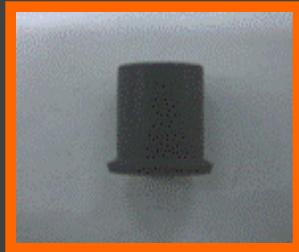


Trimming rules

- Rule A: You don't need the function anymore
- Rule B: The object performs the function itself
- Rule C: Some other component does the function

Case #1: Changes Made

Before

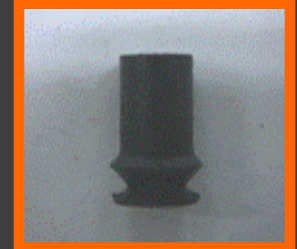


Eliminated the Compression spring and o-ring by transferring the spring effect to the suction cup

Changed the current rigid suction cup to a bellows suction cup

Segmented the Nest to a 3-piece part

After



Case #2: Device shuttle in handler



Engineering Contradiction: *If the shape of the cavity is able to cater for a particular package size, then it is able to handle that package but low flexibility/versatility when shuttle needs to change due to change in package sizes*

a) Improving parameter: Shape (12)

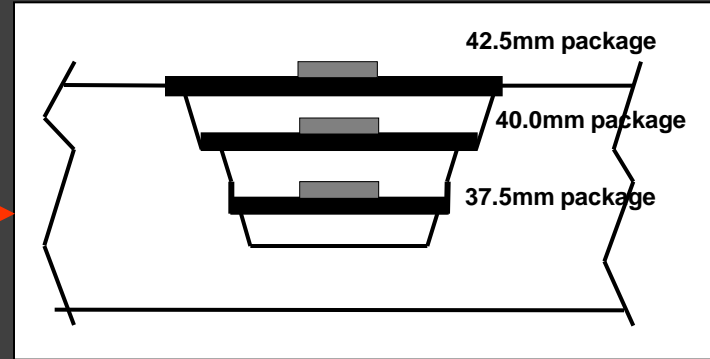
b) Worsening parameter: Ease of Mfg (32), Adaptability (35)

Inventive Principles suggested:

- **12/32: 1 (Segmentation), 32 (Color change), 17 (Another dimension), 28 (Mechanical substitution)**
- **12/35: 1 (Segmentation), 15 (Dynamization), 29 (Pneumatics)**

	Worsening Feature →	Ease of manufacture	Adaptability or versatility
	Improving Feature ↓		
		32	35
12	Shape	1, 32, 17, 28	1, 15, 29

Case #2: Device shuttle in handler



Principle used:

Another dimension: Use a multi-storey arrangement of objects instead of a single-storey arrangement

Phase 2 - Proliferation & Adoption

- **Challenge: How do you convince 10 ATM factories (i.e. 10 Factory Mgrs, 10 Assembly Eng'g Mgrs, 10 Test Eng'g Mgrs, ... in 6 sites, 4 countries) to adopt TRIZ?**
 - **Not all programs are tops down ("Just do it"). TRIZ is more bottoms up and sideways**
 - **Need factory commit for training**



▪ Strategies

- **Seek Technical Steering Council & GM approval for proliferation**
 - Based on pilot results, presented success stories and obtained approval to proliferate TRIZ to ATM
 - Instructors: CR (1) & MY (2). Fund travel to China/Philippines (3x/site)

**Use different techniques - not all will work all the time
Persistence is necessary. Networking is essential**

Phase 2 - Proliferation & Adoption

■ Strategies (cont'd)

- **Work with individual factories - different responses & needs**
 - Ability to generate innovative solutions even for >10 year old equipment & solid ROI are good motivators
 - Introduced 2 hour "TRIZ for Managers" class
- **Arranged 1/1 either FTF or over phone with all FMs**
- **If all else fails, use peer pressure**
- **Other tactics: elevator, cafeteria, hallway, ... talk**

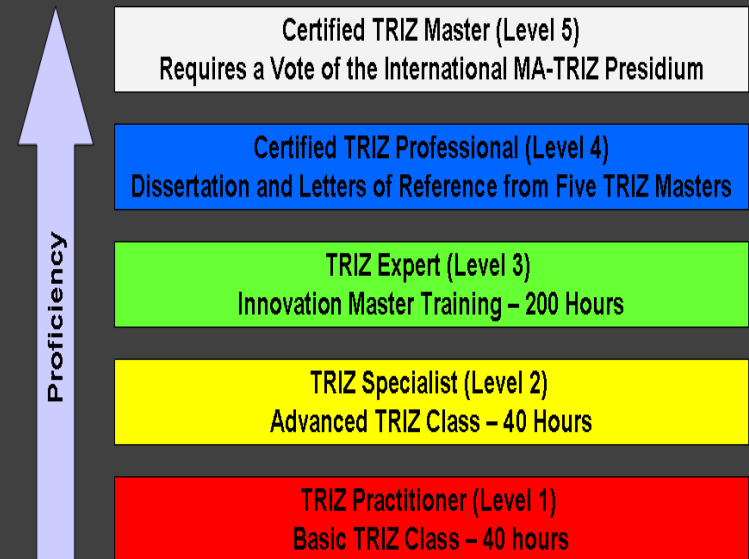
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Phase 2 - Proliferation & Adoption

■ Result

- All factories committed 100% module/equipment engineers to be trained in Basic TRIZ
- Conducted 40+ five-day workshops, 500+ students (Intel's total ~1000), completed 32 projects and generated ~\$13M ROI based primarily on sustaining manufacturing

Levels of TRIZ Proficiency



Phase 3 - Sustainability

- Challenge: How to make TRIZ a culture?
- Strategies

- **Build infrastructure**

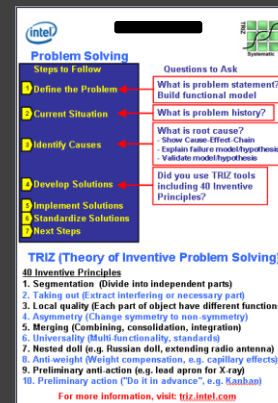
- Identify factory champions. Grow local instructors for each site
- Arrange regular management project review
- Avenue for ad-hoc engagement when problems arise

- **Need behavior change**

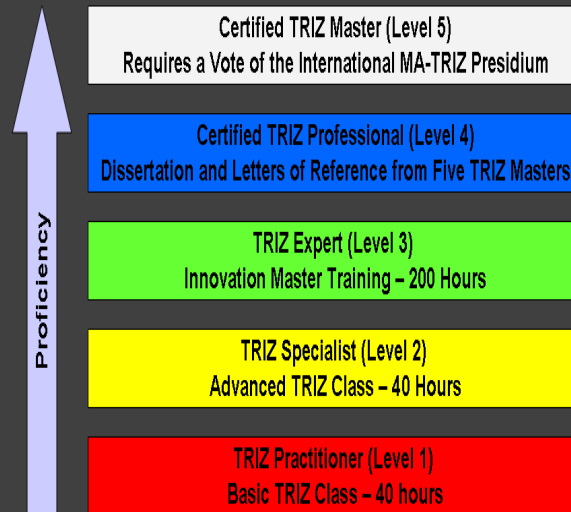
- Link to factory programs
- TRIZ for Managers class to create awareness
- Get managers & engineers to pull

- **Build TRIZ community of practice**

- Conferences to share success stories & ROI
- Badge cards
- Proficiency stickers



Levels of TRIZ Proficiency



Pushing has a limit. Need management and engineer pull

Phase 4 - Proliferation to Others

- **Challenge: Which disciplines/orgs should TRIZ be proliferated to next?**
- **Strategies**
 - **Other organizations which could potentially benefit e.g. Facilities, Technology Development,...**

Pursue new, undiscovered opportunities. It's exciting!

Key Learning

- If it's a new program with no track record, start with small wins. Need to show that program adds tangible value
- **Constant & regular 1/1 with key stake holders is essential**
- Networking is essential. It has to start now, not later
- **Trust comes with networking and interactions based on proven track record. Programs can move relatively quicker**
- Understand factory/customer issues, gear towards needs
- **Disciplined follow-up/through: key to ensure sustainability**
- Risk taking is a norm as success is not guaranteed
- **Persistence is necessary**
- Passion is key

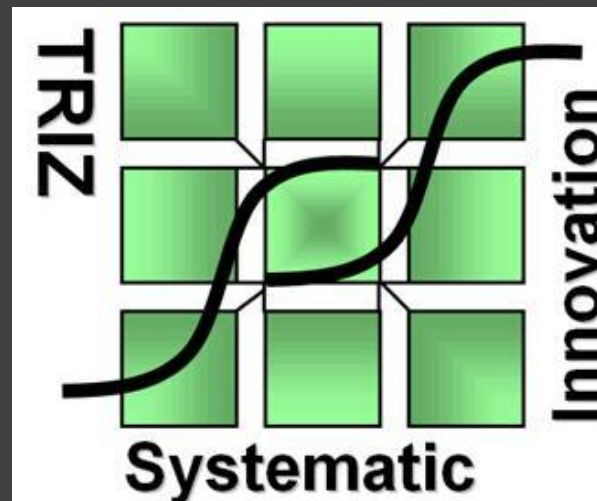
Networking, Persistence, Risk taking, Passion

Summary

- **4 phases for a new program implementation**
 - **Phase 1: Initial stage - pursue small wins**
 - **Phase 2: Proliferation & adoption - need softskills & networking**
 - **Phase 3: Sustainability - need customer pull**
 - **Phase 4: Proliferation to others - pursue new opportunities**
 - **Key learning: Need to have networking, persistence, risk taking, passion**
- **Impact**
 - **TRIZ provides additional tools for engineers to generate innovative solutions which are low cost but effectively solves problem in shortest amount of time**
- **Future plans**
 - **Proliferation to other organizations**

Conclusions

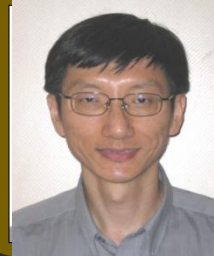
- **A Journey of a thousand miles begins with the first step!**
- **TRIZ is a key systematic innovation for Intel into the 21st century!**
- **Intel uses TRIZ effectively**
- **Process and systems improvement is just the beginning of TRIZ potential for companies!**



Acknowledgements



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Gene Meieran

Our Teachers

Our Sponsor

THANK YOU

Q&A

*"You can wait a hundred years for enlightenment,
or you can solve the problem in 15 minutes with these principles"*

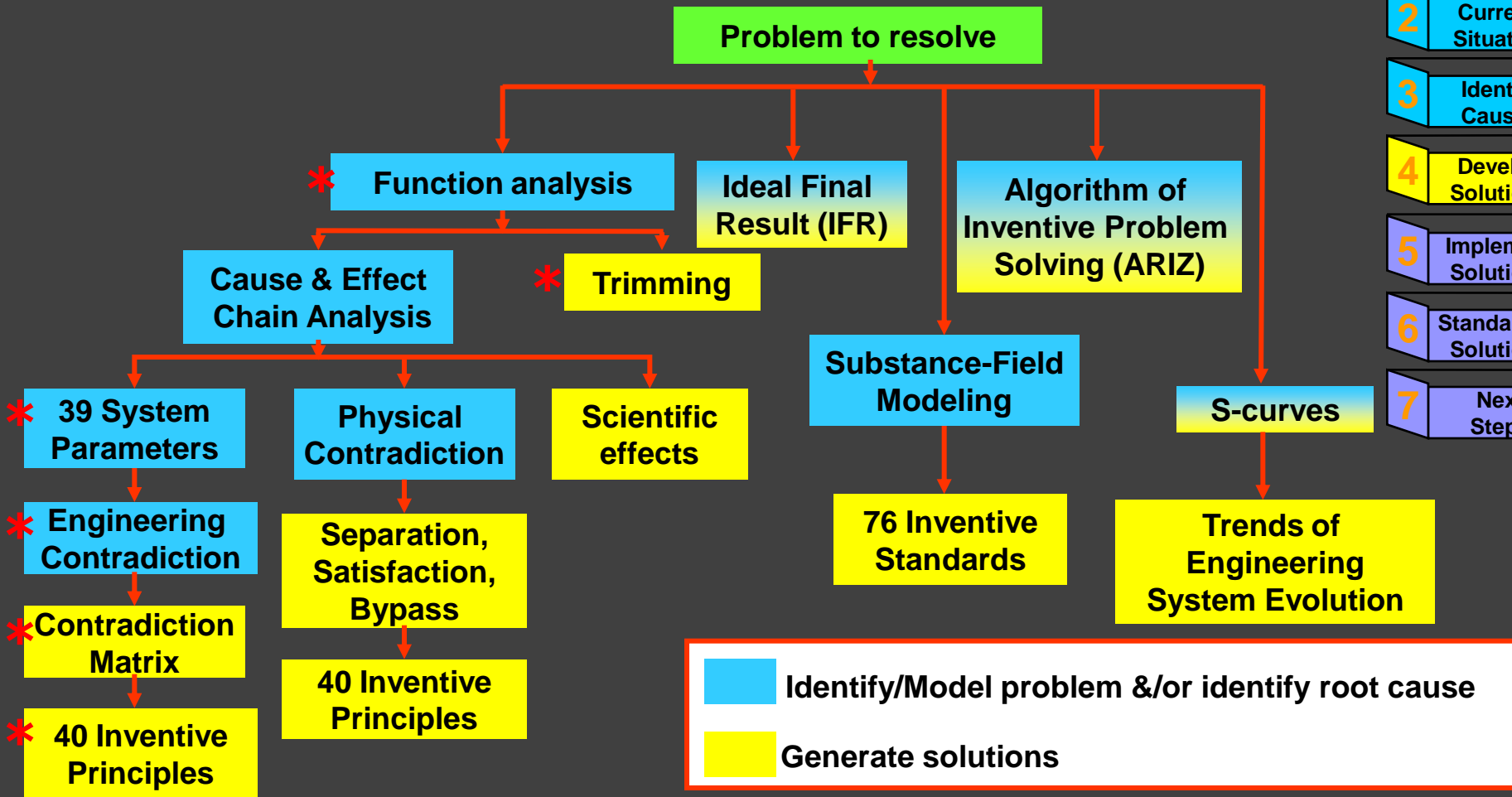
--- Genrich Altshuller, TRIZ



Back Up

TRIZ Training Overview

- 1 Define Problem
- 2 Current Situation
- 3 Identify Causes
- 4 Develop Solutions
- 5 Implement Solutions
- 6 Standardize Solutions
- 7 Next Steps



Toolbox which contains root cause analysis and solution generation tools

